| | DATE: | | SPEC. No. ED-96027 |
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| 1. Jusepa - Feb. | 27, 173 | SHARP | ISSUE February 1996 |
| | DATE: | ELECTRONIC GOMPONENTO | PAGE' 12 Pages 1 |
| J. Joshikawa Feb | . 22,1996 | ELECTRONIC COMPONENTS GROUP SHARP CORPORATION | REPRESENTATIVE DIVISION |
| | | SPECIFICATION | OPTO-ELECTRONIC DEVICES DIV. |
| | | | <u> </u> |
| | DEVICE | SPECIFICATION FOR | |
| | | PHOTOCOUPLER | |
| | MODEL I | PC3H4 | |
| | | Business dealing name : PC3H4 | |
| SHARP (1) This Ma • (2) Plea is t • U • T [• C (3) Plea | takes no restaction takes no restaction uses of the Computer Measuring edused for the Init concernity of the Safety ase do not used for the Space equiproses of the Space equiproses of the Safety as the Space equiproses of the Safety of the | ructions mentioned below for actual use of the sponsibility for damage caused by improper usesigned for general electronic equipment. This device are as follows: OA equipment Telecommunication equipment Tooling machine OAV equipment OBY | ipment (Terminal) nent · Home appliance, etc. safety, in case this device liability. train, automobile etc.) and burglar alarm box ire extremely high reliability. |
| devices | | | = |
| CUSTOMER'S | APPROVA | DATE PRESENT BY | TED Jill |
| DATE | | Depa Engir | atsumura, ortment General Manager of neering Dept. ,11 |
| ВУ | | ELEC | o-Electronic Devices Div. COM Group RP CORPORATION |

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1. Application

This specification applies to the outline and characteristics of photocoupler; Model No. PC3H4.

2. Outline

Refer to the attached drawing No. CY8374K02.

3. Ratings and characteristics

Refer to the attached sheet, page 3 to 5.

4. Reliability

Refer to the attached sheet. page 6.

5. Incoming inspection

Refer to the attached sheet, page 7.

6. Supplement

- 6.1 Isolation voltage shall be measured in the following method.
 - (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
 - (2) The dielectric withstand tester with zero-cross circuit shall be used.
 - (3) The wave form of applied voltage shall be a sine wave.
- 6.2 This product is AC input type.
- 6.3 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

6.4 Packaging specifications

Refer to the attached sheet, page 8 to 10.

6.5 The business dealing name used for this product when ordered or delivered shall be PC3H4.

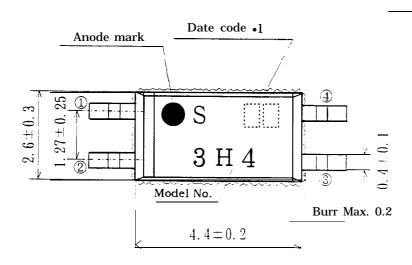
7. Notes

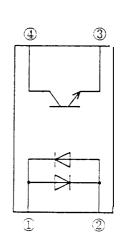
Refer to the arrached sheet-1 -1, 2

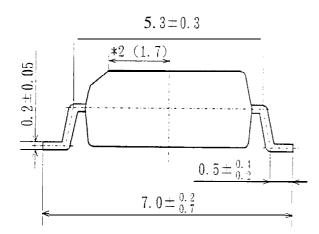
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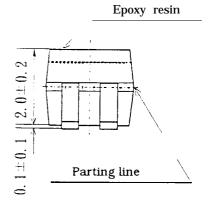
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Pin Nos. and internal connection diagram









- *1) 2-digit number shall be marked according to DIN standard
- *2) Dimensions in parenthesis are shown for reference.
- *3) Marking is laser marking

| | UNIT: 1/1 mm |
|----------------|--|
| Name | PC3H4 Outline Dimensions (Business dealing name : PC3H4) |
| Drawing No. | CY8374K02 |

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3. Ratings and characteristics

3.1 Absolute maximum ratings

Ta=25℃

| Parameter | | Symbol | Rating | unit |
|---|---------------------------------|--------------------|-------------|-------|
| | * 1 Forward current | $I_{\overline{F}}$ | ±50 | mA |
| Input | *2 Peak forward current | I_{FM} | ±1 | A |
| | * 1 Power dissipation | P | 70 | mW |
| | Collector-emitter voltage | v _{CEO} | 70 | V |
| output | Emitter-collector voltage | V _{ECO} | 6 | V |
| output | Collector current | Ic | 50 | mA |
| | * 1 Collector power dissipation | Pc | 150 | mW |
| * 1 Total power dissipation Operating temperature Storage temperature *3 Isolation voltage | | Rot | 170 | mW |
| | | Topr | -30 to +100 | `c |
| | | Tstg | -40 to +125 | 'c |
| | | Viso | 2.5 | kVrms |
| | *4 Soldering temperature | Tso1 | 260 | 'c |

^{*1} The derating factors of absolute maximum ratings due to ambient temperature are shown in Fig. 1 to $4\,$.

^{*2} Pulse width $\leq 100 \,\mu$ s. Duty ratio :0.00 (Refer to Fig. 5)

^{*3} AC for 1 min, 40 to 60%RH, f=60Hz

^{*4} For 10s

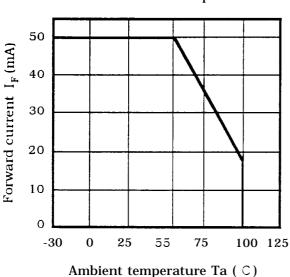
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3.2 Electro-optical characteristics

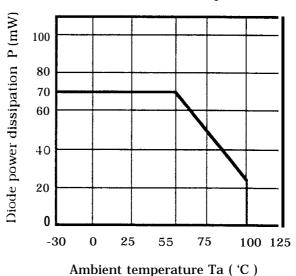
Ta=25°C

| | Parameter | symbol | Conditions | MIN. | TYP. | MAX. | unit |
|----------------------------------|--|----------------------|--|--------------------|------|------|------|
| Immunt | Forward voltage | $V_{\rm F}$ | $I_F = \pm 20 \text{mA}$ | | 1.2 | 1,4 | v |
| Input | Terminal capacitance | Ct | V=0, f=1kHz | | 30 | 250 | pF |
| | Dark current | I_{CEO} | $V_{CE} = 50V, I_{F} = 0$ | | | 100 | пA |
| output | Collector-emitter breakdown voltage | BV _{CEO} | Ic=0.1 mA I _F =0 | 70 | - | - | v |
| | Emitter-collector breakdown voltage | BV _{ECO} | $I_E = 10 \mu A, I_F = 0$ | 6 | - | - | v |
| | Collector current | Ic | $I_F = \pm 1 \text{mA}, V_{CE} = 5V$ | 0.2 | - | 4.0 | mA |
| | Collector-emitter saturation voltage | V _{CE(sat)} | $I_{\rm F} = \pm 20 \text{mA}$ $I_{\rm C} = 1 \text{mA}$ | | 0.1 | 0.2 | v |
| Transfer charac- teristics | Isolation resistance | Riso | DC500V 40 to 60%RH | 5×10 ¹⁰ | 10¹' | - | Ω |
| | Floating capacitance | Cf | V=0, f=1 MHz | | 0.6 | 1.0 | pF |
| | Response time (Rise) | tr | V _{CE} =2V Ic=2mA | | 4 | 18 | μS |
| | Response time (Fall) | tf | $R_L = 100 \Omega$ | | 3 | 18 | μS |

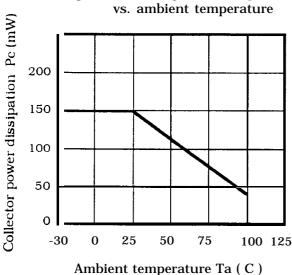
(Fig. 1) Forward current vs. ambient temperature



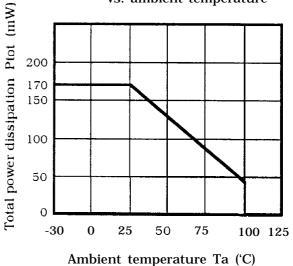
(Fig. 2) Diode power dissipation vs. ambient temperature



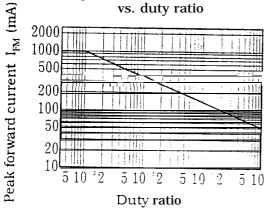
(Fig. 3) Collector power dissipation



(Fig. 4) Total power dissipation vs. ambient temperature



(Fig. 5) Peak forward current vs. duty ratio



Pulse width $\leq 100 \,\mu\,\mathrm{s}$ Ta=25℃

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| | | | ` | | | - 3 ⁸⁶ 0 |

Confidence level: 90%

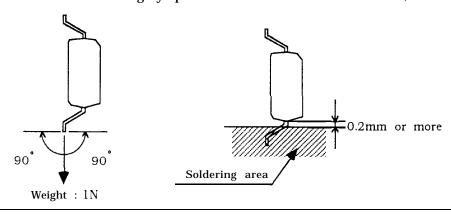
LTPD: 10%/20%

4. Reliability

The reliability of products shall be satisfied with items listed below.

| Test Items | Test Conditions | Failure Judgement Criteria | Samples (n) Defective(C) | | |
|--------------------------------------|---|---|--------------------------|--|--|
| Solderability *2 | 230°C,5S | | n=11, C=0 | | |
| Soldering heat *3 | 260°C, 10 s | | n=11, C=O | | |
| Terminal strength (Bending) *4 | Weight: 1 N 1 time/each terminal | $V_F>U\times1.2$ | n=11, C=0 | | |
| Mechanical shock | $15000 \text{m/s}^2, 0.5 \text{ms}$ 3 times/ $\pm X, \pm Y, \pm Z$ direction | $I_{CEO} > U \times 2$ $I_{CEO} < L \times 0.7$ | n=11, C=0 | | |
| Variable frequency vibration | 100 to 2000 to 100Hz/4min 200m/s ² 4 times/ X, Y, Z direction | $\mathbf{v}_{\text{CE(sat)}} > \mathbf{u} \times 1.2$ | n=11. C=0 | | |
| Temperature cycling | 1 cycle -40°C to +125°C (30min) (30min) 20 cycles test | II . Haran | n=22.C=0 | | |
| High temp. and high humidity storage | +85℃, 85 %RH, 500h *5 | U : Upper specification limit | n=22,C=0 | | |
| High temp. storage | +125°C,1000h | L: Lower | n=22,C=0 | | |
| Low temp. storage | -40℃, 1000 h | s pec ification limit | n=22,C=0 | | |
| Operation life | I _F =50mA. Ptot=170mW Ta=25'C, 1000h | | n=22,C=0 | | |

- *1 Test method, conforms to JIS C 7021.
- *2 Solder shall adhere at the area of 95% or more of immersed portion of lead and pin hole or other holes shall not be concentrated on one portion.
- $^{\ast}3$ The lead pin depth dipped into solder shall be away O .2mm from the root of lead pins,
- *4 Terminal bending direction is shown below.
- *5 It evaluates after washing by specified solvent in attach sheet-1 -1, 2.



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5. Incoming inspection

- 5.1 Inspection items
 - (1) Electrical characteristics

$$V_{F}, I_{CEO}, V_{CE(sat)}, Ic, Riso, Viso$$

- (2) Appearance
- 5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level 11 based on 1SO 2859 is applied. The AQL according to the inspection items are s hewn below.

| Defect | Inspection item | AQL (Ye) |
|-----------------|--|----------|
| Major defect | Electrical characteristics Unreadable marking | 0.1 |
| Minor defect | Appearance defect except the above mentioned. | 0.4 |

| | - | | | |
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| | | | 3.0 | |

6.3 Package specifications

6.3.1 Taping conditions

(1) Tape structure and Dimensions (Refer to the attached sheet, Page 9)

The tape shall have a structure in which a cover tape is sealed heat-pressed on the carrier tape of protect against static electricity.

(2) Reel structure and Dimensions (Refer to the attached sheet, Page 10)

The taping reel shall be of corrugated cardboard with its dimensions as shown in the attached drawing

(3) Direction of product insertion (Refer to the attached sheet, Page 10)

Product direction in carrier tape shall direct to the anode mark at the hole side on the tape.

(4) Joint of tape

The cover tape and carrier tape in one reel shall be jointless.

(5) The way to repair taped failure devices

The way to repair taped failure devices cut a bottom of earner tape with a cutter, and after replacing to good devices, the cutting portion shall be sealed with adhesive tape.

6.3.2 Adhesiveness of cover tape

The exfoliation force between carrier tape and cover tape shall be 0.2N to 0.7N for the angle from 160' to 180"

6.3.3 Rolling method and quantity

• Wind the tape back on the reel so that the cover tape will be outside the tape. Attach more than 20cm of blank tape to the trailer and the leader of the tape and fix the both ends with adhesive tape. One reel shall contain 3000pcs.

6.3.4 Marking

.The outer packaging case shall be marked with following information.

* Model No. * Number of pieces delivered * Production date

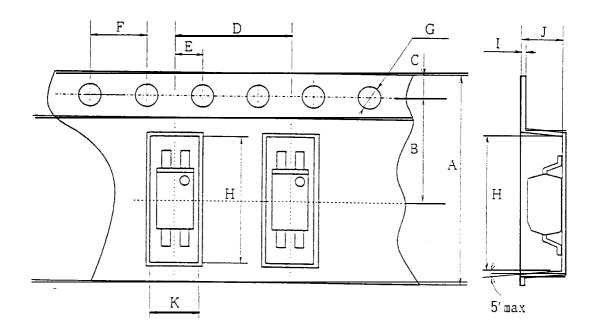
6.3.5 Storage condition

• Taped products shall be stored at the temperature lower than 5 to 30°C and the humidities lower than 70%RH.

6.3.6 Safety protection during shipping

There shall be no deformation of component or degradation of electrical characteristics due to shipping.

Carrier tape structure and Dimensions

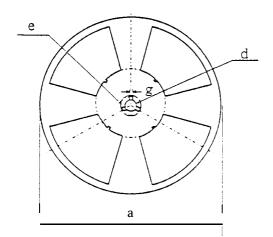


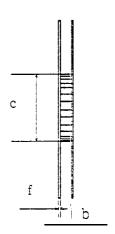
| Symbol | A | В | С | D | E | F |
|--------|------|-------------|----------------------|---------------------|-------------|----------|
| mm | ±0.3 | ±0.1 5.5 | * 0.1 1.75 | * 0.1 8.0 | ±0.1 2.0 | ±0.1 4.0 |

| Symbol | G | Н | I | J | K |
|--------|------------------------|------|-------|-------------|------|
| mm | +0.1 -0.0 \$ 1.5 | ±0.1 | ±0.05 | ±0.1 2.3 | ±0.1 |

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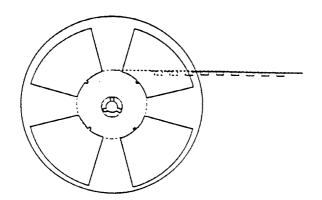
Reel structure and Dimensions



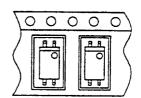


| Symbol | | Check word | | | | | |
|--------|-----|------------|-------|--------|------|---------|---------|
| unit | a | b | c | d | e | f | ga |
| mm | 330 | 13.5* 1.5 | 100±1 | 13±0.5 | 23±1 | 2.0±0.5 | 2.010.5 |

Direction of product insertion



Pull-out direction



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PC3H4; Attach sheet lad

Precautions for Photocouplers

1 For cleaning

(1) Solvent cleaning : Solvent temperature 45°C or less Immersion for 3 min or less

(2) Ultrasonic cleaning: The affect to device by ultrasonic cleaning is different

by cleaning bath size, ultrasonic power

output, cleaning time, PWB size or device mounting condition etc. Please test it in actual using condition and confirm that doesn't occur any defect before starting

the ultrasonic cleaning.

Applicable solvent: Ethyl alcohol, Methyl alcohol, Freon TE, TF Diflon-solvent S3-E, Trichloroethane

Please refrain from using Chloro Fluoro Carbon type solvent to clean devices as much as possible since it is internationally restricted to protect the ozonosphere. Before you use alternative solvent you are requested to confirm that it does not attack package resin.

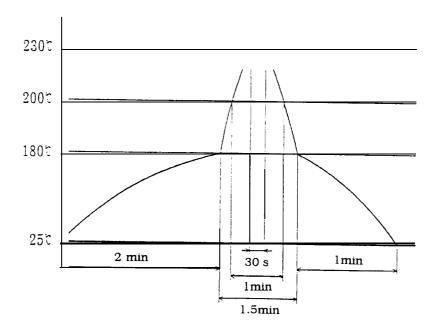
2. The LED used in the Photocoupler generally decreases the light emission power by operation. In case of long operation time, please design the circuit with considering the degradation of the light emission power of the LED. (50% / 5years)

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| PC3H4 | To Attack |
| | sheet-1-2: |

3. Precautions for Soldering Photocouplers

(1) If solder reflow:

It is recommended that only one soldering be done at the temperature and the time within the temperature profile as s hewn in the figure.



Since, influence to the device is different according to reflow equipment and its condition, please use the device after confirming no damage in the actual using condition.

(2 Other precautions

An infrared lamp used to heat up for soldering may cause a localized temperature rise in the resin. So keep the package temperature within that specified in Item (1). Also avoid immersing the resin part in the solder.